Technical Data Sheet

0603 Package Chip LED (0.4mm Height)

GT-197

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The GT-197 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

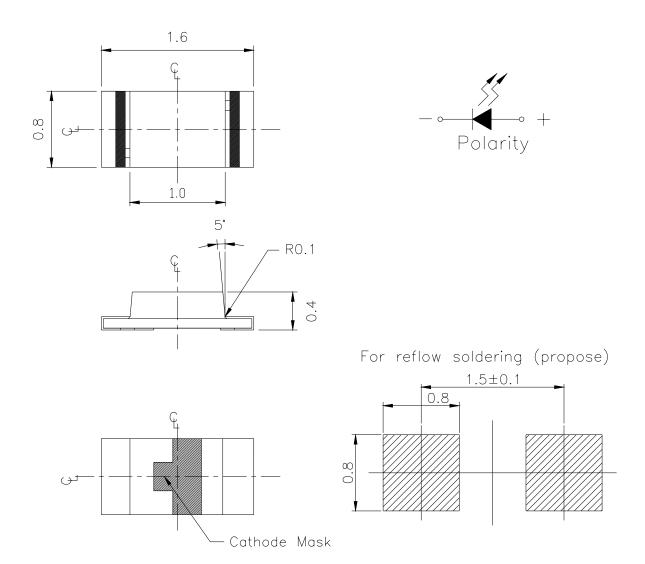
- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

D (N	Cl	Destruction	
Part No.	Material	Emitted Color	Resin Color
GT197	InGaN	Pure White	Yellow Diffused

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Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	${ m I}_{ m F}$	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA
Power Dissipation	Pd	110	mW
Electrostatic Discharge(HBM)	ESD	150	V
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	Reflow Soldering : 260 Hand Soldering : 350	

Electro-Optical Characteristics (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
	_	28.5		112	•	IF=5mA
Luminous Intensity	Iv		200		mcd	IF=20mA
Viewing Angle	2 \theta 1/2		130		deg	I _F =5mA
Forward Voltage	***	2.70		3.30	*7	IF=5mA
	VF		3.3		V	IF=20mA
Reverse Current	Ir			50	μΑ	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Forward Voltage ±0.1V

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
N	28.5	45.0		
P	45.0	72.0	mcd	IF=5mA
Q	72.0	112		

Bin Range Of Forward Voltage

Bin	Min	Max	Unit	Condition
29	2.70	2.80		
30	2.80	2.90		
31	2.90	3.00		In Em A
32	3.00	3.10	V	IF=5mA
33	3.10	3.20		
34	3.20	3.30		

Notes:

1.Tolerance of Luminous Intensity ±11%

2. Tolerance of Forward Voltage $\pm 0.1V$

Chromaticity Coordinates Specifications for Bin Grading

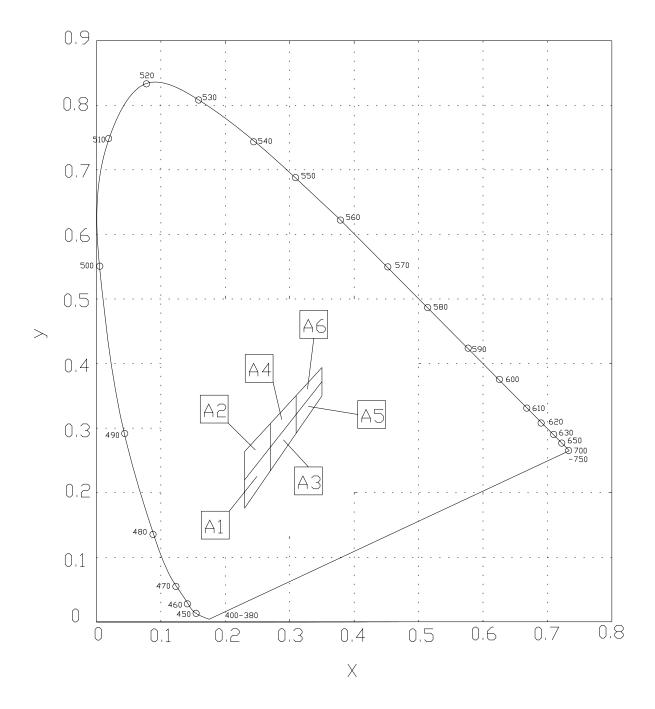
Bin Code	CIE_x	CIE_y	Condition
	0.230	0.176	
A 1	0.230	0.219	
A1	0.270	0.270	
	0.270	0.234	
	0.230	0.219	
A2	0.230	0.263	
A2	0.270	0.307	
	0.270	0.270	
	0.270	0.234	
A3	0.270	0.270	
AS	0.310	0.321	
	0.310	0.292	I _F = 5mA
	0.270	0.270	IF— JIIIA
A4	0.270	0.307	
A4	0.310	0.350	
	0.310	0.321	
	0.310	0.292	
A5	0.310	0.321	
AS	0.350	0.372	
	0.350	0.350	
	0.310	0.321	
A6	0.310	0.350	
AU	0.350	0.393	
	0.350	0.372	

Notes:

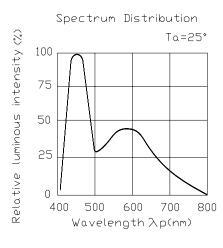
1.The C.I.E. 1931 chromaticity diagram (Tolerance ± 0.01).

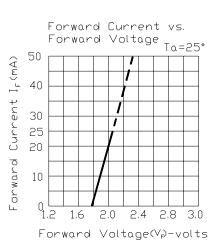
2. The products are sensitive to static electricity and care must be fully taken when

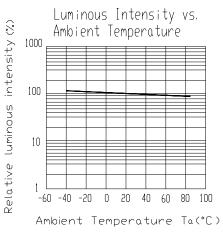
CIE Chromaticity Diagram

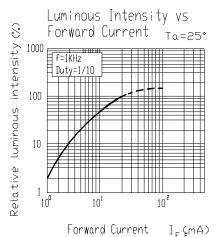


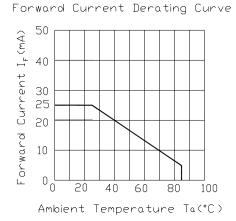
Typical Electro-Optical Characteristics Curves

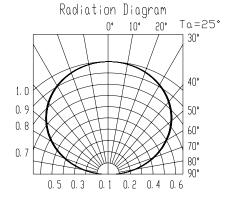






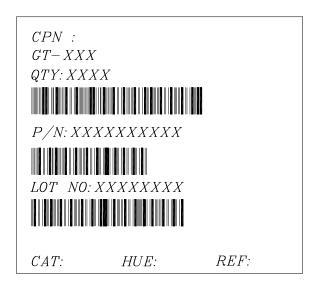




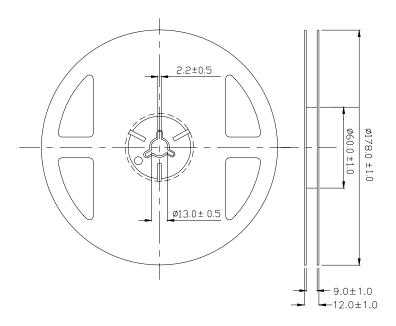


Label explanation

CAT: Luminous Intensity Rank HUE: Chromaticity Coordinates REF: Forward Voltage Rank

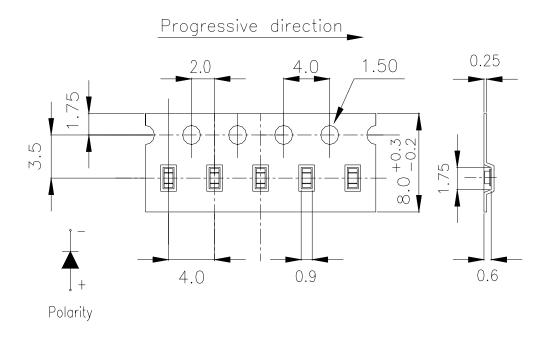


Reel Dimensions



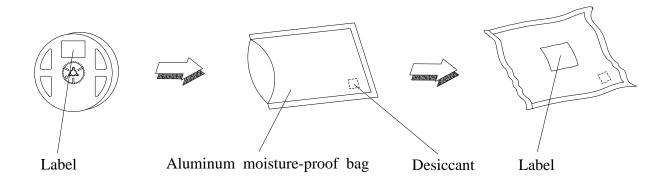
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA} / 25^{\circ}\text{C}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1.Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

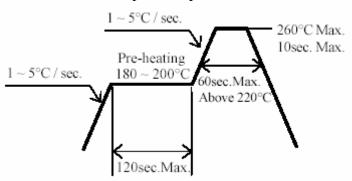
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1Pb-free solder temperature profile

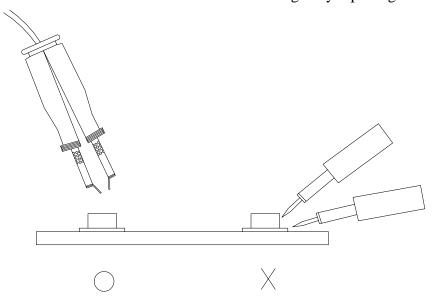


- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound

单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)